

# **350V N-Channel Enhancement Mode MOSFET**

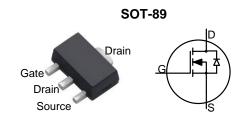
#### **General Features**

- Proprietary Advanced Planar Technology
- Rugged Polysilicon Gate Cell Structure
- Fast Switching Speed
- RoHS Compliant
- ➢ Halogen-free available

#### **Applications**

- ➢ High Efficiency SMPS
- Adaptor/Charger
- > Active PFC

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> (Max.)	I <sub>D</sub>
350V	15 Ω	200mA



 $T_{\star}$  -25°C unless otherwise specified

# **Ordering Information**

Part Number	Package	Marking	Remark
FTX15N35G SOT-89		N35	Halogen Free

## **Absolute Maximum Ratings**

Absolute Maximum Ratings		I <sub>A</sub> =25 C unless otherwise specified	
Symbol	Parameter	FTX15N35G	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage <sup>[1]</sup>	350	V
I <sub>D</sub>	Continuous Drain Current	0.2	٨
I <sub>DM</sub>	Pulsed Drain Current <sup>[2]</sup>	0.6	А
P <sub>D</sub>	Power Dissipation	1.0	W
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V
T <sub>L</sub>	Soldering Temperature Distance of 1.6mm from case for 10 seconds	300	°C
$T_{J}$ and $T_{STG}$	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

## **Thermal Characteristics**

Symbol	Parameter	FTX15N35G	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	125	K/W



# **Electrical Characteristics**

#### **OFF** Characteristics

OFF Characteristics				$T_A = 25^{\circ}C$ unless otherwise specified			
Symbol	Parameter	Min.	Тур.	Max.	Unit	<b>Test Conditions</b>	
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	350			V	$V_{GS}$ =0V, $I_{D}$ =250 $\mu$ A	
$\triangle BV_{DSS} / \triangle T_J$	Breakdown Voltage Temperature Coefficient		0.35		V/°C	Reference to 25°C, $I_D=250 \mu A$	
				1	μΑ	$V_{DS}=350V, V_{GS}=0V$	
I <sub>DSS</sub>	Drain-to-Source Leakage Current			100	μΑ	$V_{DS}=350V, V_{GS}=0V$ $T_{J}=125^{\circ}C$	
I <sub>GSS</sub>	Gate-to-Source Leakage Current			20		$V_{GS}$ =+20V, $V_{DS}$ =0V	
				-20	μA	$V_{GS}$ =-20V, $V_{DS}$ =0V	

#### **ON** Characteristics

ON Characteristics				$T_A = 25^{\circ}C$ unless otherwise specified			
Symbol	Parameter	Min.	Тур.	Max.	Unit	<b>Test Conditions</b>	
R <sub>DS(ON)</sub>	Static Drain-to-Source On-Resistance		8	15	Ω	$V_{GS}$ =10V, $I_D$ =200mA <sup>[3]</sup>	
V <sub>GS(TH)</sub>	Gate Threshold Voltage	1		3	V	$V_{GD} = 0V, I_D = 250 \mu A$	

### **Dynamic Characteristics**

Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
C <sub>ISS</sub>	Input Capacitance		32.58			V <sub>GS</sub> =0V
C <sub>OSS</sub>	Oput Capacitance		5.36		pF	$V_{DS}=25V$
C <sub>RSS</sub>	Reverse Transfer Capacitance		0.75			f=1.0MHz
t <sub>d(ON)</sub>	Turn-on Delay Time		14			
t <sub>rise</sub>	Rise Time		10		ns	$\label{eq:VDD} \begin{split} V_{DD} &= 25 V, \ I_D {=} 80 m A \\ R_G &= 25 O h m \\ V_{GS} &= 10 V {\sim} 0 V \end{split}$
t <sub>d(OFF)</sub>	Turn-off Delay Time		24			
t <sub>fall</sub>	Fall Time		36			

Source-Drain Diode Characteristics		$T_A=25^{\circ}C$ unless otherwise specified				
Symbol	Parameter	Min	Тур.	Max.	Units	<b>Test Conditions</b>
V <sub>SD</sub>	Diode Forward Voltage			1.8	V	$I_{SD} = 200 \text{ mA}, V_{GS} = 0 \text{ V}$

#### NOTE:

[1] T<sub>J</sub>=+25°C to +150°C

[2] Repetitive rating, pulse width limited by maximum junction temperature.

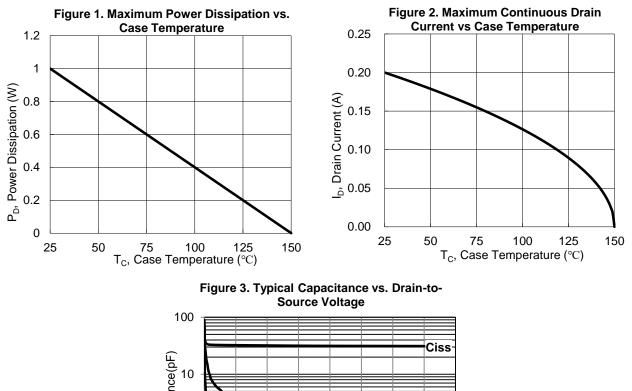
[3] Pulse width $\leq$ 380 µs; duty cycle $\leq$ 2%.

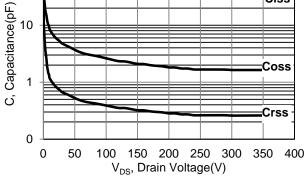
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2 / 5

# Typical Characteristics





# **Switching Waveforms and Test Circuit**

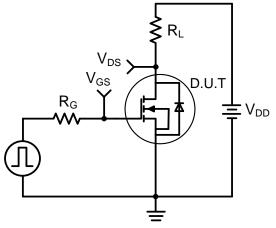


Figure 4. Resistive Switching Test Circuit

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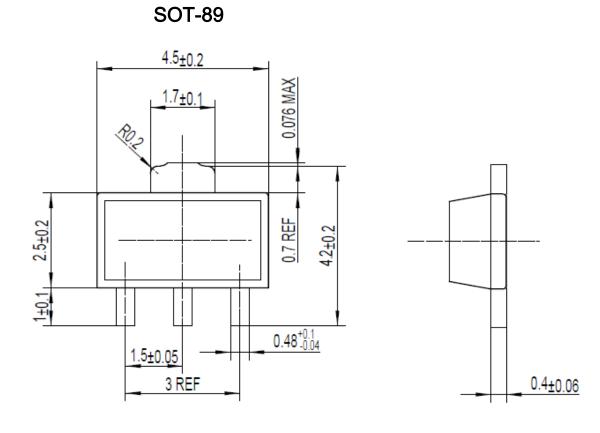
Figure 5. Resistive Switching Waveforms

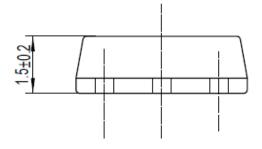
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Rev. 2.0 Jan. 2020



# **Package Dimensions**





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